

2A 5V-Adjustable Low Dropout Voltage Regulator

Rev. 1.2.3

July 28, 2023

GENERAL DESCRIPTION

The XRP6272 is a low dropout voltage regulator capable of a constant output current up to 2 Amps. A wide 1.8V to 6V input voltage range allows for single supply operations from industry standard 1.8V, 2.8V, 3.3V, and 5V power rails as well as the 5.8V rail.

With better than ±2% output voltage accuracy, low output noise and high Power Supply Rejection Ratio (PSRR), the XRP6272 is perfectly suited for powering RF circuitries. Optimized for use with small low cost ESR ceramic output capacitors and featuring a low 30µA quiescent current, this device is also adequate for use in battery powered portable equipments. The XRP6272 operates by default as a 5V fixed output voltage regulator while usage of an external resistors divider allows adjustable out voltages as low as 0.7V. An Enable function, Power Good flag and output noise reduction pin complete the feature set.

Built-in current limit and thermal protections insure safe operations under abnormal operating conditions.

The XRP6272 is offered in RoHS compliant, "green"/halogen free 5-pin TO-252 and 8-pin exposed pad SOIC packages.

TYPICAL APPLICATION DIAGRAM

APPLICATIONS

- Networking Equipments
- **RF Circuitry Power Supplies**
- Set-top box Equipments
- Portable Equipments

FEATURES

- Guaranteed 2A Output Current
 - Low 550mV Dropout at 3.3V/2A
- 1.8V to 6V Single Input Voltage Range
 - Fixed 5V and Adjustable Output Voltage
 - ±2% Output Voltage Accuracy
- 30µA Quiescent Current
- Power Good and Enable Functions
- 70dB Power Supply Rejection Ratio
- Low Output Noise
- 0.01µA Shutdown Current
- Current Limit and Thermal Protection
- RoHS compliant "Green"/Halogen Free 5-pin TO-252 and 8-pin Exposed pad SOIC Packages

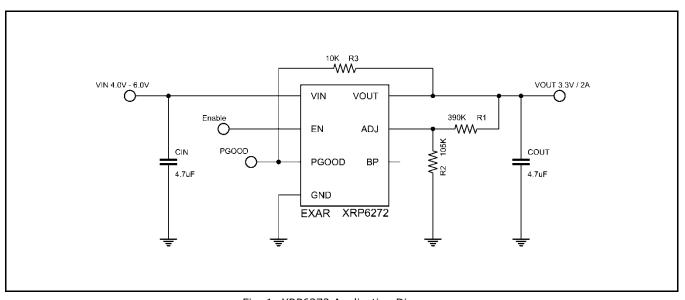


Fig. 1: XRP6272 Application Diagram



ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

| V _{IN} , EN, BP | 7.0V |
|--------------------------------------|----------------------|
| Storage Temperature | 65°C to 150°C |
| Power Dissipation | . Internally Limited |
| Lead Temperature (Soldering, 10 sec) | 260°C |
| Junction Temperature | 150°C |
| ESD Rating (HBM - Human Body Model) | 2kV |
| ESD Rating (MM - Machine Model) | 500V |

OPERATING RATINGS

| Input Voltage Range V _{IN} 1.8 | V to 6V |
|---|---------|
| Operating Temperature Range40°C | to 85°C |
| Thermal Resistance | |
| θ _{JA} (5-Pin TO-252)1 | 00°C/W |
| θ _{JC} (5-Pin TO-252) | . 8°C/W |
| A. (8-pip HSOIC) | |

| Θ_{JA} (8-pin HSOIC) | 60°C/W |
|-------------------------------|--------|
| θ _{JC} (8-pin HSOIC) | 15°C/W |

ELECTRICAL SPECIFICATIONS

Specifications with standard type are for an Operating Junction Temperature of $T_J = 25^{\circ}$ C only. Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at $T_J = 25^{\circ}$ C, and are provided for reference purposes only. Unless otherwise indicated, $V_{IN} = V_{OUT} + 1V$, $C_{IN} = 4.7\mu$ F, $C_{OUT} = 4.7\mu$ F or 10μ F (Note 1), $C_{BYP} = 22n$ F, $T_J = 25^{\circ}$ C.

| Parameter | Min. | Тур. | Max. | Units | Conditions |
|---|-------|------|-------|--------|--|
| Input Voltage | 1.8 | | 6.0 | V | |
| Output Voltage Tolerance | -2 | | +2 | % | I _{OUT} = 1mA |
| Continuous Output Current | 2 | | | A | $V_{IN} \ge 2.3V$ |
| Consumed Community | | 30 | 50 | | $V_{EN} \ge 1.6V$, No Load |
| Ground Current | | 30 | 50 | μA | $V_{EN} \ge 1.6V$, $I_{OUT} = 300mA$ |
| Standby Current | | 0.01 | 0.5 | μA | $V_{EN} = 0$ |
| Line Regulation | | 3 | 15 | mV | $V_{IN} = V_{OUT} + 1V$ to 6V, $I_{OUT} = 1mA$ |
| Load Regulation | | 5 | 15 | mV | I _{OUT} =1mA to 2A |
| Output Current Limit | 2.2 | 3.0 | 3.9 | Α | |
| Current Fold Back | | 1.0 | | Α | |
| | | 960 | | | Iout = 2A, Vout =1.2V |
| | | 700 | 900 | mV | $I_{OUT} = 2A, V_{OUT} = 1.8V$ |
| Dropout Voltage (Note 2) | | 550 | 700 | 111V | $I_{OUT} = 2A, V_{OUT} = 3.3V$ |
| | | 480 | 600 | | Iout = 2A, Vout = 5.0V |
| Reference Voltage Tolerance | 0.686 | 0.7 | 0.714 | V | |
| ADJ Pin Current | | 10 | 100 | nA | $V_{ADJ} = V_{REF}$ |
| ADJ Pin Threshold | 0.05 | 0.1 | 0.2 | V | |
| Enable Turn-On Threshold | 1.6 | | | V | Output ON |
| Enable Turn-Off Threshold | | | 0.4 | V | Output OFF |
| Shutdown Pin Current | | 0 | 0.5 | μA | $V_{EN} = 0$ |
| Shutdown Exit Delay Time | | 100 | | μs | |
| Max Output Discharge Resistance to GND during Shutdown | | 20 | 100 | Ω | |
| PGOOD Rise Threshold | | 90 | 93 | % | |
| PGOOD Hysteresis | 3 | 10 | | % | |
| PGOOD Delay | 0.5 | | 5 | ms | |
| PGOOD Sink Capability | | 0.2 | 0.4 | V | $I_{PGOOD} = 10 mA$ |
| Ripple Rejection | | 70 | | dB | f=1KHz, Ripple=0.5Vp-p |
| Output Noise Voltage | | 24 | | μVrms | C _{BP} = 22nF, f=10Hz ~100KHz |
| Temperature Coefficient | | 50 | | ppm/°C | |
| Thermal Shutdown Temperature | | 150 | | °C | $V_{IN} = V_{OUT} + 1V$ |



2A 5V-Adjustable Low Dropout Voltage Regulator

| Parameter | Min. | Тур. | Max. | Units | Conditions |
|-----------------------------|------|------|------|-------|------------|
| Thermal Shutdown Hysteresis | | 20 | | °C | |

Note 1: In the case of $V_{OUT} \le 1.8V$, $C_{OUT} = 10\mu F$ is recommended.

Note 2: Dropout Voltage is defined as input voltage minus output voltage when the output voltage drops by 1% of its nominal value at $V_{IN} = V_{OUT} + 1V$.

Note 3: $V_{IN (min)}$ is the higher value of (V_{OUT} + Dropout Voltage) or 1.8V.

BLOCK DIAGRAM

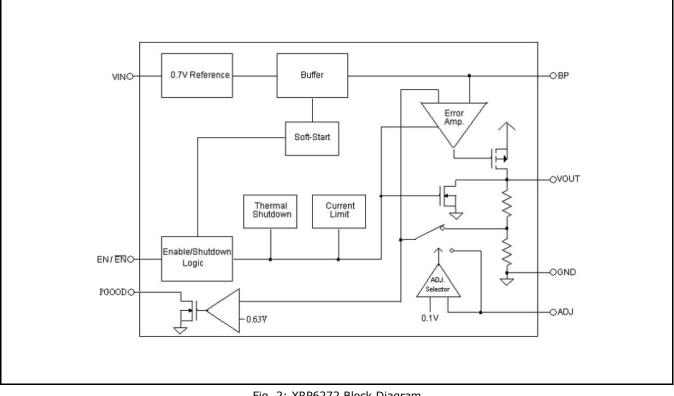
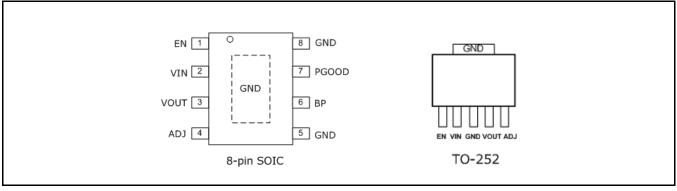
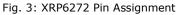


Fig. 2: XRP6272 Block Diagram

PIN ASSIGNMENT







PIN DESCRIPTION

| Name | SOIC-8 | TO-252 | Description |
|-------|-------------|--------|--|
| EN | 1 | 1 | Enable Pin. Minimum 1.6V to enable the device. Maximum 0.4V to shut down the device. |
| VIN | 2 | 2 | Power Input Pin. Must be closely decoupled to GND pin with a $4.7\mu F$ or greater ceramic capacitor. |
| VOUT | 3 | 4 | Regulator Output pin. |
| ADJ | 4 | 5 | Adjustable Pin. Output Voltage can be set by external feedback resistors when using a resistive divider. Or, connect ADJ to GND for VOUT = 5V, set by internal feedback resistors. |
| GND | 5, 8 | 3 | Ground Signal |
| BP | 6 | - | Bypass pin. Connect a 22nF capacitor to GND to reduce output noise. Bypass pin can be left floating if not necessary. |
| PGOOD | 7 | - | Power Good open Drain Output. |
| GND | Exposed Pad | Tab | Connect to GND. |

ORDERING INFORMATION

| Part Number | Operating Temperature Range | Package | Packing Method | Lead-Free |
|-----------------|---|--------------|----------------|-----------|
| XRP6272ITC5TR-F | $-40^{\circ}C \le T_{A} \le +85^{\circ}C$ | 5-pin TO-252 | Tape & Reel | Yes |
| XRP6272IDBTR-F | -40°C ≤ T _A ≤ +85°C | 8-pin HSOIC | Tape & Reel | Yes |

NOTE: For more information about part numbers, as well as the most up-to-date ordering information and additional information on environmental rating, go to <u>www.maxlinear.com/XRP6272</u>.



TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at $V_{IN} = V_{OUT} + 1V$, $T_J = T_A = 25^{\circ}$ C, $C_{IN} = 4.7\mu$ F, $C_{OUT} = 4.7\mu$ F or 10μ F (Note 1) unless otherwise specified.

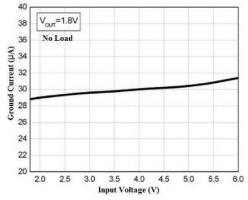


Fig. 4: GND Current vs. VIN at VOUT=1.8V, No Load

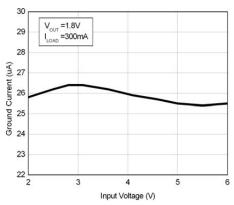


Fig. 6: GND Current vs. VIN at VOUT=1.8V, 300mA

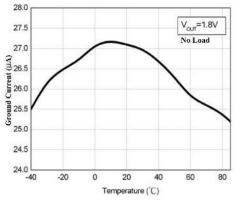
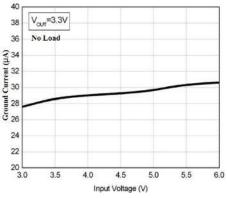


Fig. 8: GND Current vs. Temp. at VOUT=1.8V, No Load



XRP6272

Fig. 5: GND Current vs. VIN at VOUT=3.3V, No Load

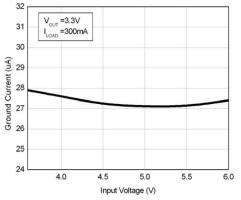


Fig. 7: GND Current vs. VIN at VOUT=3.3V, 300mA

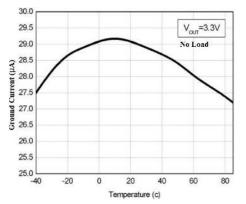


Fig. 9: GND Current vs. Temp. at VOUT=3.3V, No Load



2A 5V-Adjustable Low Dropout Voltage Regulator

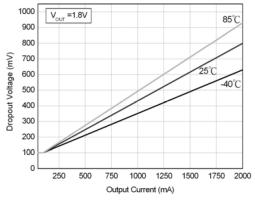


Fig. 10: Dropout Voltage at VOUT = 1.8V

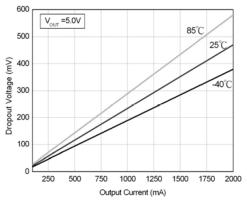


Fig. 12: Dropout Voltage at VOUT = 5.0V

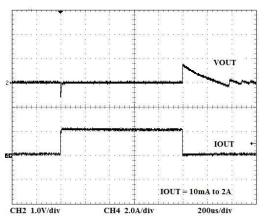
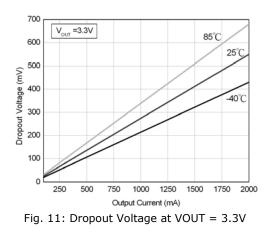


Fig. 14: Load Transient Response at VOUT=3.3V, VIN=4.3V



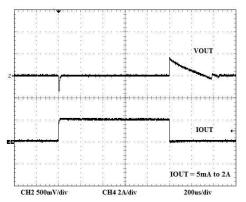


Fig. 13: Load Transient Response at VOUT=1.8V, VIN=2.8V

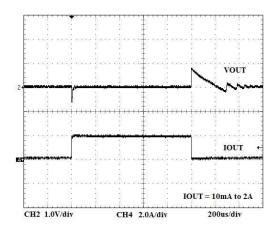
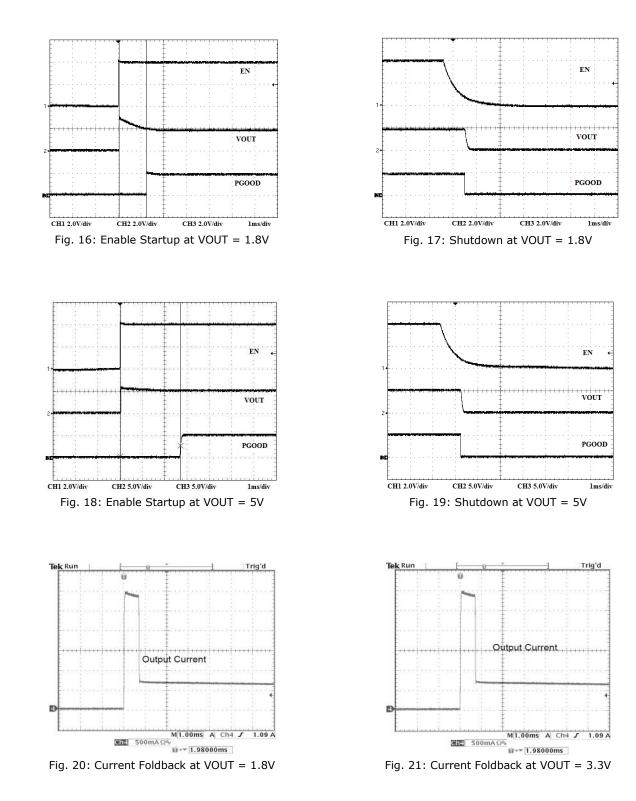


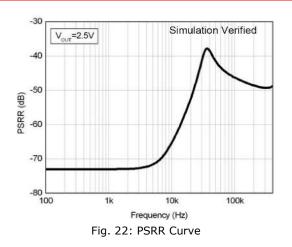
Fig. 15: Load Transient Response at VOUT=5V, VIN=6V



2A 5V-Adjustable Low Dropout Voltage Regulator



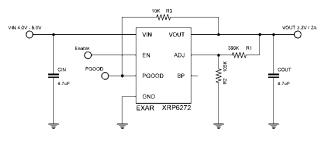




APPLICATION INFORMATION

The XRP6272 is a low-dropout voltage regulator with low quiescent current, low noise and high PSRR. It can support load current up to 2A. It incorporates current-limit and thermal protection features.

TYPICAL APPLICATION SCHEMATIC



PROGRAMMING THE OUTPUT VOLTAGE

XRP6272's internal feedback resistors set the output voltage V_{OUT} to 5V when the ADJ pin is connected to GND. Alternatively; the output voltage is adjustable via the external feedback resistor network R1 and R2 by calculating the following formula:

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R1}{R2}\right)$$

where, V_{REF} is the reference voltage set internally at 0.7V nominal.

INPUT & OUTPUT CAPACITORS

XRP6272 is optimized for use with ceramic capacitors. To ensure stability of the device,

an output ceramic capacitor of at least $4.7\mu F$ or $10\mu F$ (for $V_{OUT} \le 1.8V$) is recommended. An input capacitor of $4.7\mu F$ is recommended.

X5R or X7R ceramic capacitors are recommended as they have the best temperature and voltage characteristics.

NOISE BYPASS CAPACITOR

A 22nF bypass capacitor at BP pin can reduce output voltage noise. This pin can be left floating if it is unnecessary.

THEORY OF OPERATION

SHUTDOWN

By connecting EN pin to GND, the XRP6272 can be shutdown to reduce the supply current to 0.01μ A (typ.). In this mode, the output voltage of XRP6272 is equal to 0V.

CURRENT LIMIT

The XRP6272 includes current limit protection feature, which monitors and controls the maximum output current. If the output is overloaded or shorted to ground, this can protect the device from being damaged.

THERMAL PROTECTION

The XRP6272 includes a thermal protection feature that protects the IC by turning off the pass transistor when the maximum junction temperature T_3 exceeds 150°C.



POWER DISSIPATION

The power dissipation across the device can be calculated as:

$$P_D = I_{OUT} \times (V_{IN} - V_{OUT})$$

The total junction temperature is calculated as:

$$T_I = T_A + P_D \times \theta_{IA}$$

where, T_J is the junction temperature, T_A is the ambient temperature and Θ_{JA} is the thermal resistance between junction to ambient.

There is a temperature rise associated with this power dissipated while operating in a given ambient temperature. If the calculated junction temperature exceeds maximum junction temperature specification, then the built-in thermal protection feature is triggered as described previously.

To insure reliable performance, the maximum allowable power dissipation for a given ambient temperature must be considered and it can be calculated as follows:

$$P_{D(MAX)} = (T_{J(MAX)} - (T_A)) / \theta_{JA}$$

XRP6272

where, $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature and Θ_{JA} is the thermal resistance between junction to ambient. In order to insure the best thermal flow, proper mounting of the IC is required.

LAYOUT CONSIDERATION

- 1. Connect the bottom-side pad to a large ground plane for good thermal conductivity and to reduce the thermal resistance of the device.
- 2. The input capacitor C_{IN} and output capacitor C_{OUT} must be placed as close as possible to the pins V_{IN} and V_{OUT} respectively.
- 3. Use short wires to connect the power supply to pins V_{IN} and GND on the board.



TYPICAL APPLICATIONS

APPLICATION 1

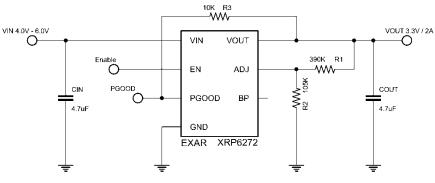


Fig. 23: 5V to 3.3V / 2A

APPLICATION 2

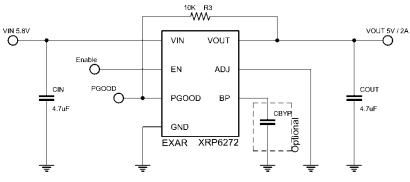


Fig. 24: 5.8V to 5V RF Stage Low Noise Power Supply

APPLICATION 3

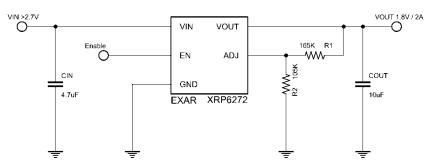
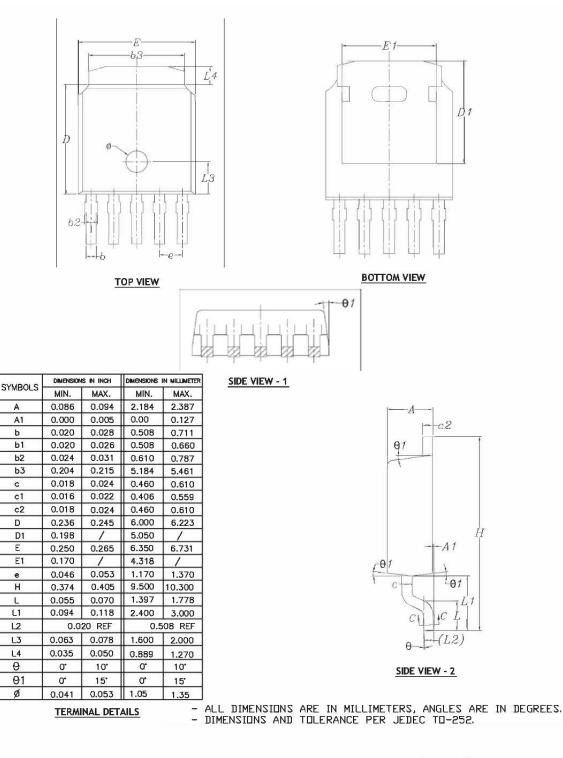


Fig. 25: 2.7V Min to 1.8V / 2A Power Supply



MECHANICAL DIMENSIONS

TO-252-5L

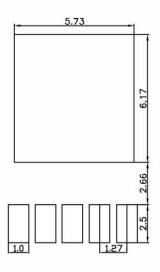


Drawing No.: POD-00000165 Revision: C

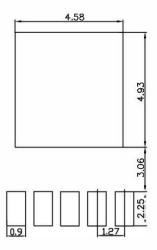


RECOMMENDED LAND PATTERN AND STENCIL

TO-252-5L



TYPICAL RECOMMENDED LAND PATTERN



TYPICAL RECOMMENDED STENCIL

Drawing No.: POD-00000165 Revision: C

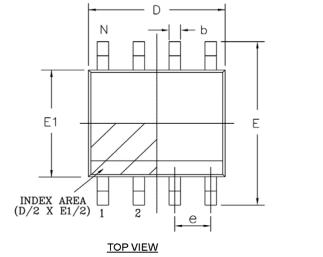


MECHANICAL DIMENSIONS AND RECOMMENDED LAND PATTERN

A1

Exposed Pad 8-Pin SOIC

А



SIDE VIEW

DIMENSIONS IN MM

NOM

1.27 BSC

8

MAX

1.75

0.15

0.51

0.25

5.00

3.50

6.20 4.00

2.55

0.50

1.27

8°

8 Pin HSOICN JEDEC MS-012 Variation BA

MIN

1.35

0.00

0.31

0.17

4.80

1.50

5.80

3.80

1.00

0.25

0.40

0°

TERMINAL DETAILS

SYMBOLS

А

A1

b

С

D

D1

Е

E1

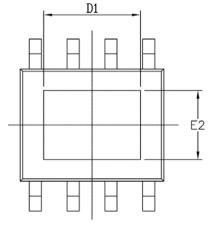
E2

е

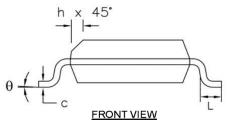
h

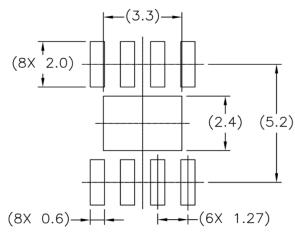
L 0

Ν



BOTTOM VIEW





LAND PATTERN RECOMMENDED

NOTE : ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREE

Drawing No. : POD - 00000125 Revision: A



REVISION HISTORY

| Revision | Date | Description | | | | |
|----------|--------------------|--|--|--|--|--|
| 1.1.0 | 10/14/2011 | Initial release of Data Sheet. | | | | |
| 1.2.0 | 11/30/2011 | Corrected pin assignment package drawing. | | | | |
| 1.2.1 | 11/01/2019 | Jpdated to MaxLinear logo. Updated Ordering Information. | | | | |
| 1.2.2 | September 10, 2021 | Updated: TO-252-5L POD's Mechanical Dimensions. Exposed Pad 8-Pin SOIC POD's Mechanical Dimensions. Added: TO-252-5L POD's Recommended Land Pattern and Stencil. Exposed Pad 8-Pin SOIC POD's Recommended Land Pattern. | | | | |
| 1.2.3 | July 28, 2023 | Updated: TO-252-5L POD's Mechanical Dimensions and TO-252-5L POD's Recommended Land Pattern and Stencil: from Revision A to Revision C. No change to content; MxL document registration only. | | | | |



MaxLinear, Inc.: 5966 La Place Court Suite 100 Carlsbad, CA 92008 Tel.: +1 (760) 692-0711 Fax: +1 (760) 444-8598 www.maxlinear.com

The content of this document is furnished for informational use only, is subject to change without notice, and should not be construed as a commitment by MaxLinear, Inc. MaxLinear, Inc. assumes no responsibility or liability for any errors or inaccuracies that may appear in the informational content contained in this document. Complying with all applicable copyright laws is the responsibility of the user. Without limiting the rights under copyright, no part of this document may be reproduced into, stored in, or introduced into a retrieval system, or transmitted in any form or by any means (electronic, mechanical, photocopying, recording, or otherwise), or for any purpose, without the express written permission of MaxLinear, Inc.

EXCEPT AS OTHERWISE PROVIDED EXPRESSLY IN WRITING BY MAXLINEAR, AND TO THE MAXIMUM EXTENT PERMITTED BY LAW: (A) THE MAXLINEAR PRODUCTS ARE PROVIDED ON AN "AS IS" BASIS WITHOUT REPRESENTATIONS OR WARRANTIES OF ANY KIND, INCLUDING WITHOUT LIMITATION ANY IMPLIED OR STATUTORY WARRANTIES AND ANY WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, NON-INFRINGEMENT, OR TITLE; AND (B) MAXLINEAR DOES NOT GUARANTEE THAT THE PRODUCTS WILL BE FREE OF ERRORS OR DEFECTS. MAXLINEAR PRODUCTS SHOULD NOT BE USED IN ANY EMERGENCY, SECURITY, MILITARY, LIFE-SAVING, OR OTHER CRITICAL USE CASE WHERE A FAILURE OR MALFUNCTION COULD CAUSE PERSONAL INJURY OR DEATH, OR DAMAGE TO OR LOSS OF PROPERTY. USERS ASSUME ALL RISK FOR USING THE MAXLINEAR PRODUCTS IN SUCH USE CASE. CUSTOMERS AND USERS ARE SOLELY RESPONSIBLE FOR USING THEIR OWN SKILL AND JUDGMENT TO DETERMINE WHETHER MAXLINEAR PRODUCTS ARE SUITABLE FOR THE INTENDED USE CASE.

MaxLinear, Inc. may have patents, patent applications, trademarks, copyrights, or other intellectual property rights covering subject matter in this document. Except as expressly provided in any written license agreement from MaxLinear, Inc., the furnishing of this document does not give you any license to these patents, trademarks, copyrights, or other intellectual property.

MaxLinear, the MaxLinear logo, any other MaxLinear trademarks (including but not limited to MxL, Full-Spectrum Capture, FSC, AirPHY, Puma, AnyWAN, VectorBoost, MXL WARE, and Panther), and the MaxLinear logo on the products sold are all property of MaxLinear, Inc. or one of MaxLinear's subsidiaries in the U.S.A. and other countries. All rights reserved.

All third-party products, company names and logos are trademarks[™] or registered® trademarks and remain the property of their respective holders/owners. Use of such marks does not imply any affiliation with, sponsorship or endorsement by the owners/holders of such trademarks. All references by MaxLinear to third party trademarks are intended to constitute nominative fair use under applicable trademark laws.

The URLs provided are for informational purposes only; they do not constitute an endorsement or an approval by MaxLinear of any of the products or services of the corporation or organization or individual. MaxLinear bears no responsibility for the accuracy, legality or content of the external site or for that of subsequent links. Contact the external site for answers to questions regarding its content.

© 2023 MaxLinear, Inc. All rights reserved.